

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name, and I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: ENHANCED CHIP SCALE PACKAGE FOR FLIP CHIPS, the specification of which (check applicable box(es):

which a patent is sought on the invel	ntion entitled: ENHANCED C	HIP SCALE PACKAGE FOR I	FLIP OF III O , E.I.			
specification of which (check applica	DIE DUX(62).					
[X]is attached hereto;	as U.S. Application Serial No and (if					
conficable to H.S. of PC, application w	03 OHIOHOUT THE					
I hereby state that I have reviewed the daims, as amended by any ame	and understand the contenendment referred to above.	ts of the above-identified speci				
I acknowledge the duty to disclosure accordance with 37 C.F.R. 1.56(a) foreign application(s) for patent or application for patent or inventor's colaimed or, if no priority is claimed by	inventor's certificate listed b	elow and have also identified to before that of the application of	below any foreign			
Prior Foreign Application(s): Application Number	Country	Day/Month/Year Filed				
I hereby claim the benefit under 35 listed below and, insofar as the su prior application in the manner prior disclose material information as de applications and the national or PC	rovided by the first paragraphics of the street in 37 C.F.R. 1.56(a) was a	oh of 35 U.S.C. 112, I acknow which occurred between the filing this application:	vledge the duty to ag date of the prior			
/ Ipplioudor -	Month/Year Filed	Status: patented, pending,				
I hereby declare that all statemer information and belief are believed that willful false statements and the Title 18 of the United States Coapplication or any patent issued the	e like so made are punishable de and that such willful fals ereon.	le by fine or imprisonment, or bose statements may jeopardize	oth, under §1001 of the validity of the			
And I hereby appoint the Attorneys Number 24112 in the records of time, to prosecute this application therewith (all communications sho	the United States Patent at and to transact all busines	ss in the Patent and Trademar	tified by Customer odated from time to k Office connected			
	24112					
•	PATENT TRADEMARK O	FFICE 13/5/0	1			
1) Inventor's Signature	styla -	Date	Cingoporo			
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